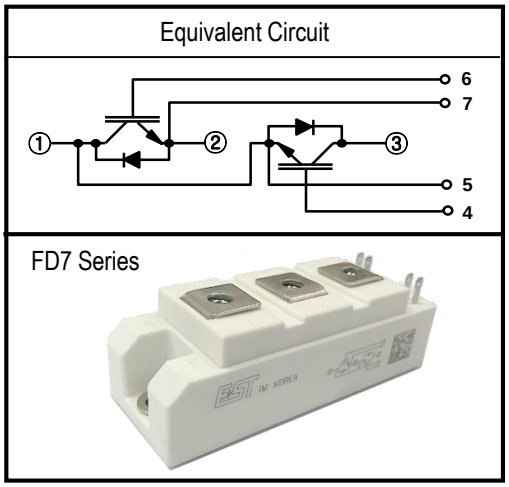
ESJ75SH60FA

High Power IGBT Module(FST)

Equivalent Circuit and Package



Please see the package out line information

Features

- BV_{CES} = 650V
- Low Conduction Loss : $V_{CE(sat)}$ = 1.65V (typ.)
- Fast & Soft Anti-Parallel FWD
- Reduced EMI and RFI
- Isolation Type Package

Applications

- Welding Machine
- Induction Heating
- UPS

Absolute Maximum Ratings @ Tc=25℃(Per Leg)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-emitter voltage	-	650	V
V_{GES}	Gate-emitter peak voltage	-	±20	V
I_C	DC-collector current	T_C = 25℃	150	A
		T_C = 80℃	75	A
I_{CM}(1)	Repetitive peak collector current	1ms	150	A
I_F	Diode continuous forward current	T_C = 80℃	75	A
I_{FM}	Diode repetitive peak forward current	-	150	A
T_J(2)	Operating junction temperature	-	-40 ~ 125	℃
T_{stg}	Storage temperature range	-	-40 ~ 125	℃
V_{ISO}	Insulation test voltage	60Hz, t=1min I_{ISOL}=1mA	2.5	kV
M_S	Mounting screw torque	M6	3.0 ~ 6.0	N.m
M_t	Mounting terminals screw torque	M5	2.5 ~ 5.0	N.m

(Note *1) Repetitive rating : Pulse width limited by max junction temperature
(Note *2) The maximum junction temperature of chip is 150℃

■ Electrical Characteristics of IGBT @ T_c=25℃ (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	C - E Breakdown Voltage	V_{GE} = 0V , I_C = 1mA	650	-	-	V
$V_{GE(th)}$	G-E threshold voltage	I_C = 10mA, V_{CE} = V_{GE}	5.2	-	7.2	V
I_{CES}	Zero gate voltage collector current	V_{GE} = 0V, V_{CE} = 600V	-	-	100	uA
I_{GES}	G-E leakage current	V_{GE} = ±20V, V_{CE} = 0V	-	-	±0.2	μA
R_{int}	Internal Gate resistor	-	-	1.7	-	Ω
$V_{CE(Sat)}$	C-E saturation voltage	I_C = 75A, V_{GE} = 15V, Tj = 25℃	-	1.65	2.0	V
		I_C = 75A, V_{GE} = 15V, Tj = 125℃	-	1.95	-	V
C_{ies}	Input capacitance	V_{GE} = 0V, f = 1MHz, V_{CE} = 25V	-	5200	-	pF
C_{oes}	Output capacitance		-	200	-	
C_{res}	Reverse transfer capacitance		-	80	-	
$t_{d(on)}$	Turn-on delay time	V_{CE} = 300V, I_C = 75A, V_{GE} = ±15V, R_G = 15Ω, T_j = 25℃, Inductive load	-	75	-	nS
t_r	Turn-on rise time		-	70	-	
$t_{d(off)}$	Turn-off delay time		-	160	-	
t_f	Turn-off fall time		-	60	-	
E_{on}	Turn-on Energy loss		-	1.0	-	mJ
E_{off}	Turn-off Energy loss		-	1.6	-	
$t_{d(on)}$	Turn-on delay time	V_{CE} = 300V, I_C = 75A, V_{GE} = ±15V, R_G = 15Ω, T_j = 125℃, Inductive load	-	80	-	nS
t_r	Turn-on rise time		-	75	-	
$t_{d(off)}$	Turn-off delay time		-	180	-	
t_f	Turn-off fall time		-	65	-	
E_{on}	Turn-on Energy loss		-	1.4	-	mJ
E_{off}	Turn-off Energy loss		-	2.1	-	
T_{sc}	Short Circuit Withstand Time	Vcc = 300V, V_{GE} = 15V, R_G = 100Ω	10	-	-	uS
Q_g	Total gate charge	V_{GE} = ±15V, V_{CE} = 300V, I_C = 75A	-	165	-	nC

■ Electrical Characteristics of FRD @ Tc=25℃ (unless otherwise specified)

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Unit
V_{FM}	Diode Forward Voltage	I_F=75A	T_j =25℃	-	2.2	2.6	V
			T_j =125℃	-	2.3	-	
t_{rr}	Diode Reverse Recovery Time	I_F=75A, V_R=300V di/dt= -1100A/uS	T_j =25℃	-	120	-	nS
			T_j =125℃	-	150	-	
I_{rr}	Diode Peak Reverse Recovery Current		T_j =25℃	-	50	-	A
			T_j =125℃	-	60	-	
Q_{rr}	G-E leakage current		T_j =25℃	-	3000	-	nC
			T_j =125℃	-	4500	-	

■ Thermal Characteristics and Weight

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction-to-Case	per IGBT	-	-	0.30	℃/W
$R_{\theta JC}$	Junction-to-Case	per DIODE	-	-	0.53	℃/W
$R_{\theta CK}$	Case-to-Heatsink (Conductive grease applied)	-	0.05	-	-	℃/W
Weight	Weight of Module		-	-	160	g

■ Performance Curves

Fig. 1 Typical IGBT output characteristics(T_j = 25℃)

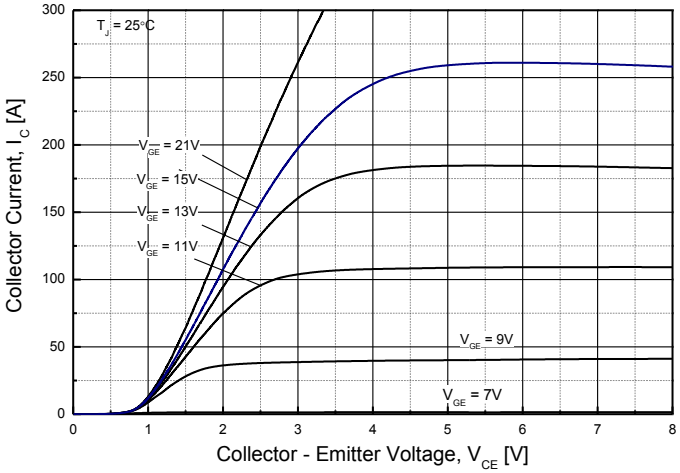


Fig. 2 Typical IGBT output characteristics(T_j= 125℃)

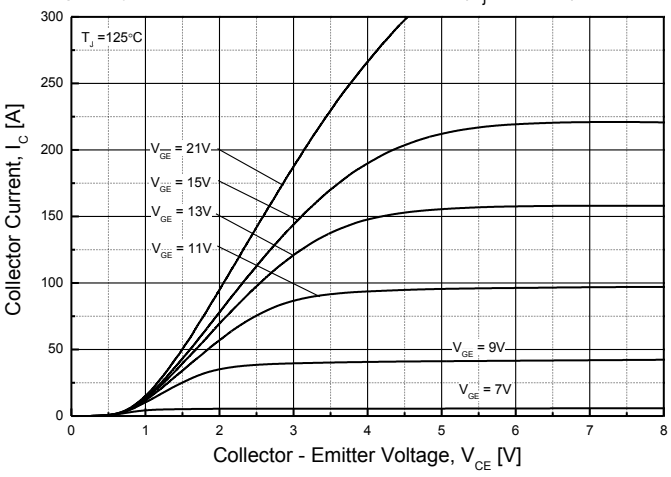


Fig. 3 Typical IGBT output characteristics

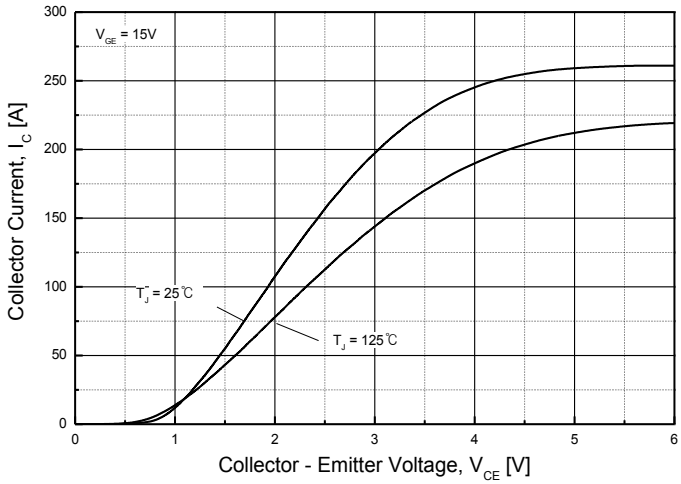


Fig. 4 Typical diode forward characteristics

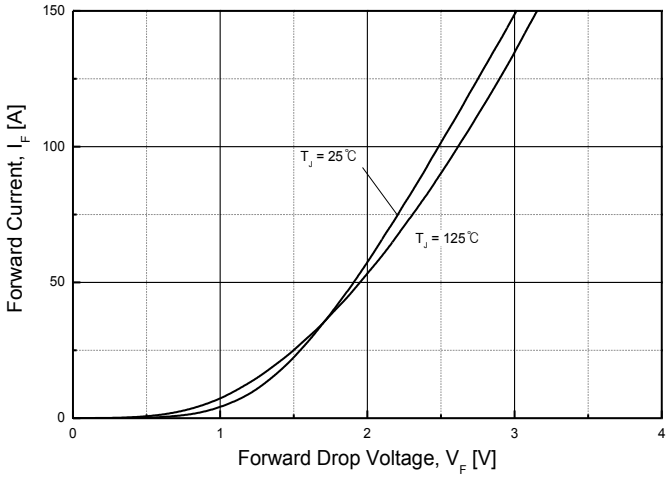


Fig. 5 Typical Switching Energy Loss =f(R_G)
V_{GE}=±15V, I_C=75A, V_{CE}=300V, T_j=25℃

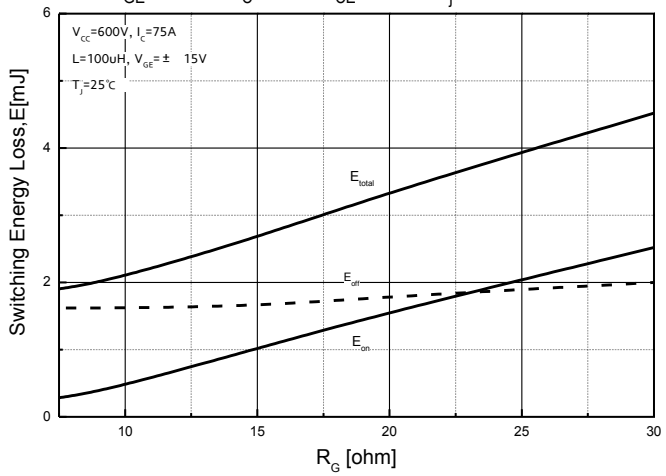
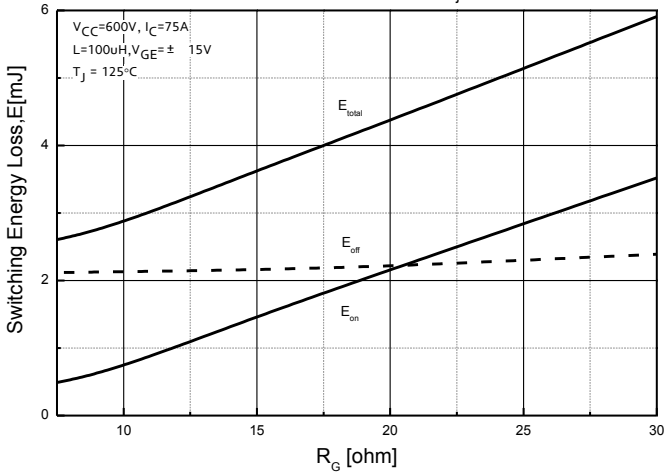


Fig. 6 Typical Switching Energy Loss =f(R_G)
V_{GE}=±15V, I_C=75A, V_{CE}=300V, T_j=125℃



■ Performance Curves

Fig. 7 Typical Switching Energy Loss =f(Ic)
V_{GE}=±15V, R_G=15Ω, V_{CE}=300V, T_j=25℃

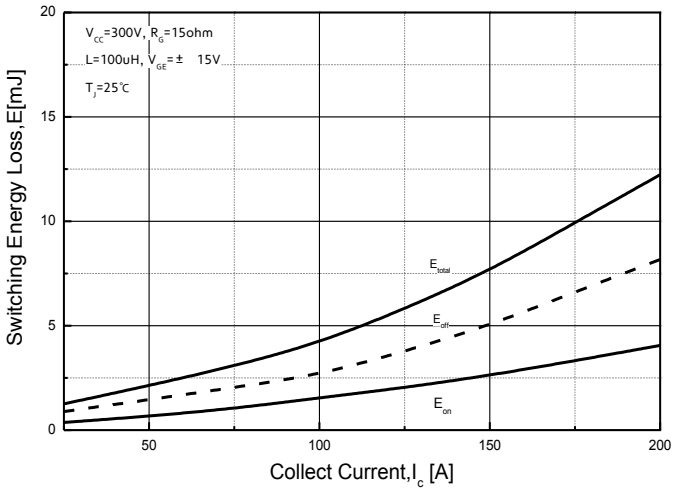


Fig. 8 Typical Switching Energy Loss =f(Ic)
V_{GE}=±15V, R_G=15Ω, V_{CE}=300V, T_j=125℃

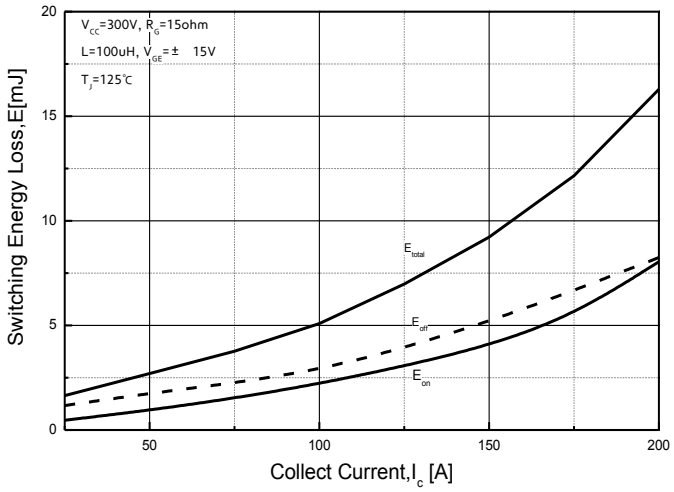


Fig. 9 Gate Charge Characteristics

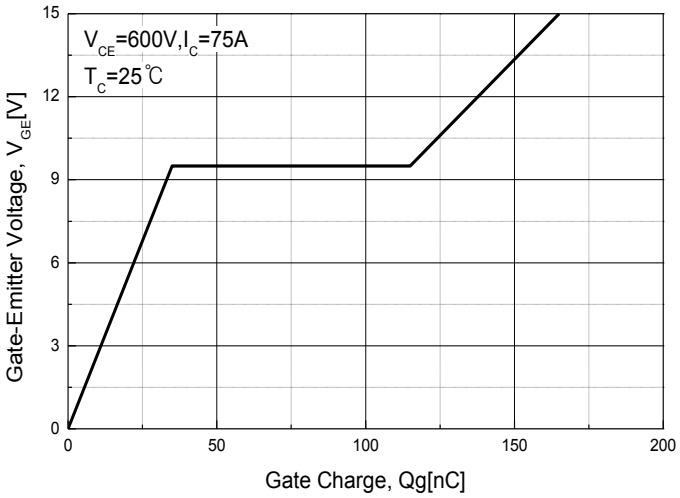
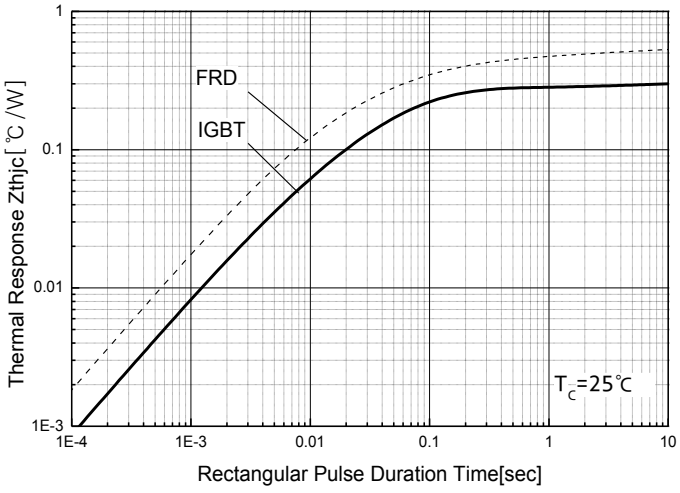


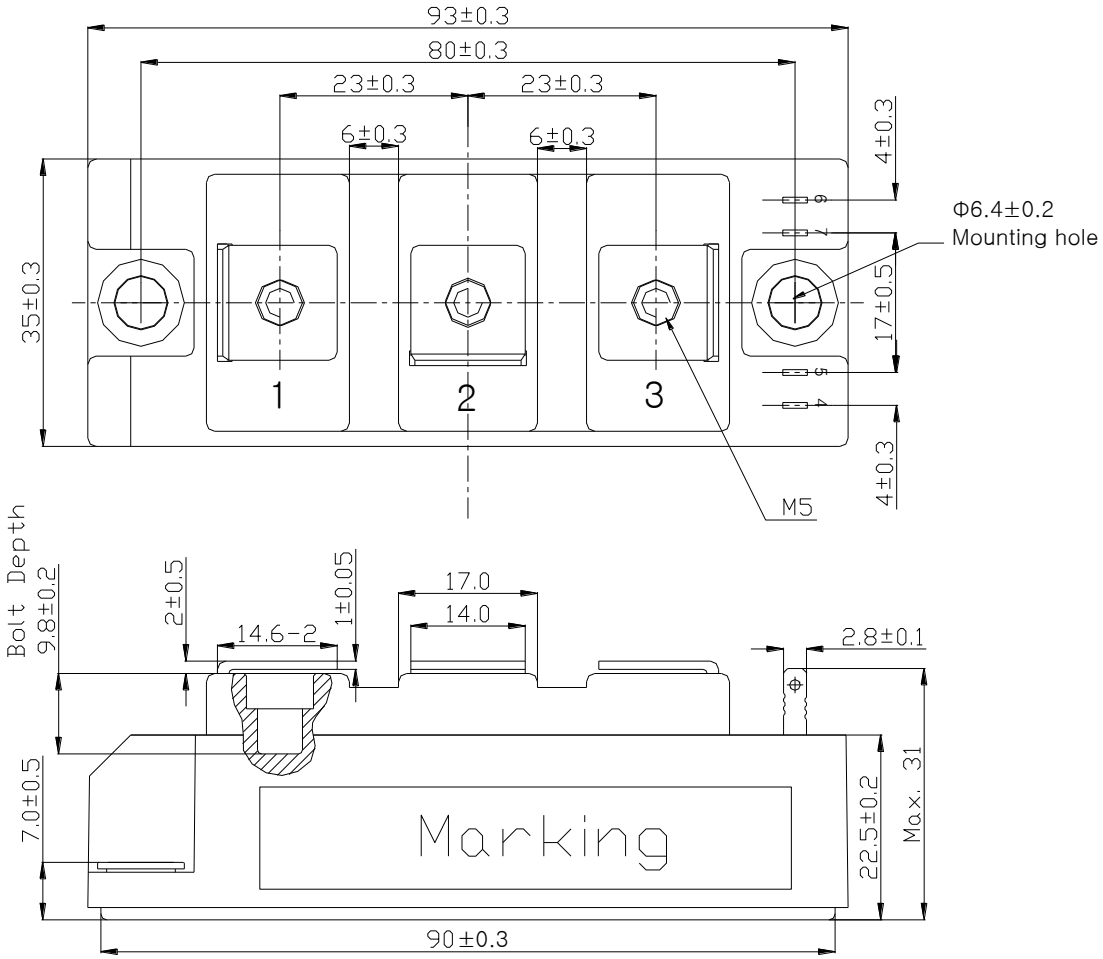
Fig. 10 Transient Thermal Resistor



■ Package Out Line Information

FD7 Package

Dimensions in mm



■ Internal Circuit